



WP321015-CSC3

SMD Type White Emitter

Features

- Side view 1204 package
- Viewing Angle = $\pm 65^\circ$
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright White
- RoHS compliance

Applications

- Optical indicator.
- Switch and Symbol Display.

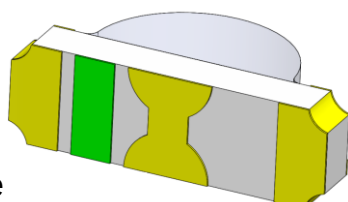
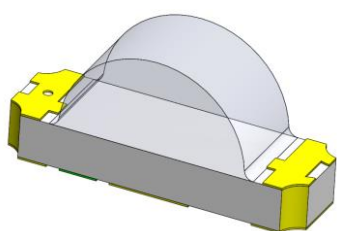
Description

The WP321015-CSC3 is an AlInGaN White LED housed in a miniature SMD package.

Static electricity and surge damage the LEDs.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

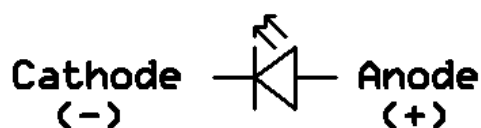
Package Outline



Cathode

Anode

Schematic





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Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
I _F	Continuous Forward Current	25	mA	
I _{FP}	Peak Forward Current	60	mA	1
V _R	Reverse Voltage	5	V	
T _{opr}	Operating Temperature	-40 ~ +85	°C	
T _{stg}	Storage Temperature	-40 ~ +100	°C	
T _{sol}	Soldering Temperature	260	°C	2
P _D	Power Dissipation at(or below) 25°C Free Air Temperature	95	mW	

Electro-Optical Characteristics *TA = 25°C (unless otherwise specified)*

Optical Characteristics

Symbol	Parameters	Test Conditions	Min	Typ	Max	Units	Notes
I _V	Luminous Intensity	I _F =5mA	130	-	350	mcd	3
θ _{1/2}	Angle of Half Intensity	I _F =5mA	-	±65	-	deg	

Electrical Characteristics

Symbol	Parameters	Test Conditions	Min	Typ	Max	Units	Notes
V _F	Forward Voltage	I _F =5mA	2.6	-	3.2	V	5
I _R	Reverse Current	V _R =5V	-	-	1	μA	

Notes:

1. I_{FP} Conditions--Pulse Width ≤ 100μs and Duty ≤ 10%.
2. Soldering time ≤ 10 seconds.
3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition
o2	130	160	mcd	I _F =5mA
p1	160	200		
p2	200	250		
q1	250	300		
q2	300	350		

Tolerance of Luminous Intensity ±10%



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4. Bin Range of Forward Voltage

Bin Code	Min	Max	Unit	Condition
33	2.6	2.7	V	I _F =5mA
34	2.7	2.8		
35	2.8	2.9		
36	2.9	3.0		
37	3.0	3.1		
38	3.1	3.2		

Tolerance of Forward Voltage $\pm 0.05V$.

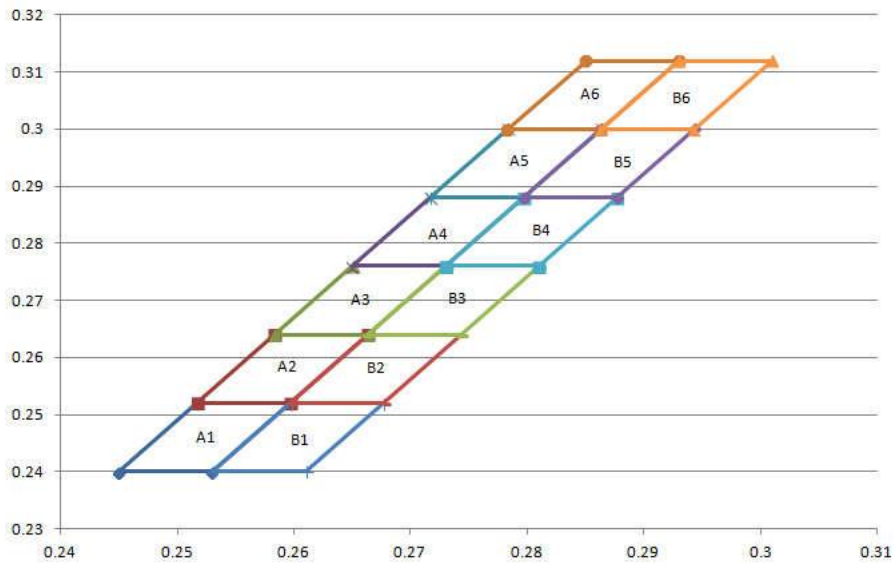
5. Bin Range of Chromaticity Coordinates

Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
A1	0.2450	0.2400	B1	0.2530	0.2400
	0.2517	0.2520		0.2597	0.2520
	0.2597	0.2520		0.2677	0.2520
	0.2530	0.2400		0.2610	0.2400
A2	0.2517	0.2520	B2	0.2597	0.2520
	0.2583	0.2640		0.2663	0.2640
	0.2663	0.2640		0.2743	0.2640
	0.2597	0.2520		0.2677	0.2520
A3	0.2583	0.2640	B3	0.2663	0.2640
	0.2650	0.2760		0.2730	0.2760
	0.2730	0.2760		0.2810	0.2760
	0.2663	0.2640		0.2743	0.2640
A4	0.2650	0.2760	B4	0.2730	0.2760
	0.2717	0.2880		0.2797	0.2880
	0.2797	0.2880		0.2877	0.2880
	0.2730	0.2760		0.2810	0.2760
A5	0.2717	0.2880	B5	0.2797	0.2880
	0.2783	0.3000		0.2863	0.3000
	0.2863	0.3000		0.2943	0.3000
	0.2797	0.2880		0.2877	0.2880
A6	0.2783	0.3000	B6	0.2863	0.3000
	0.2850	0.3120		0.2930	0.3120
	0.2930	0.3120		0.3009	0.3120
	0.2863	0.3000		0.2877	0.2880



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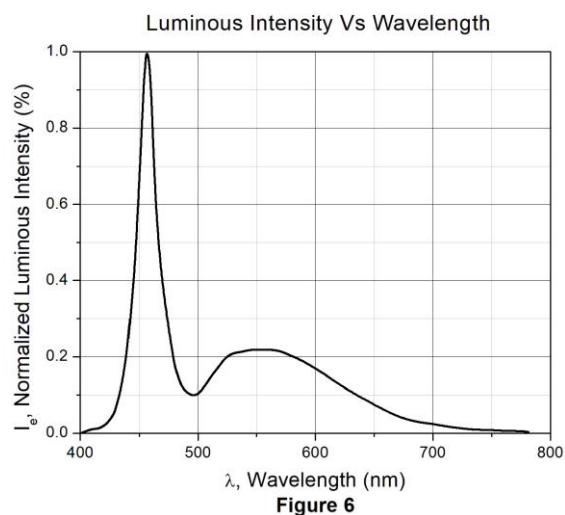
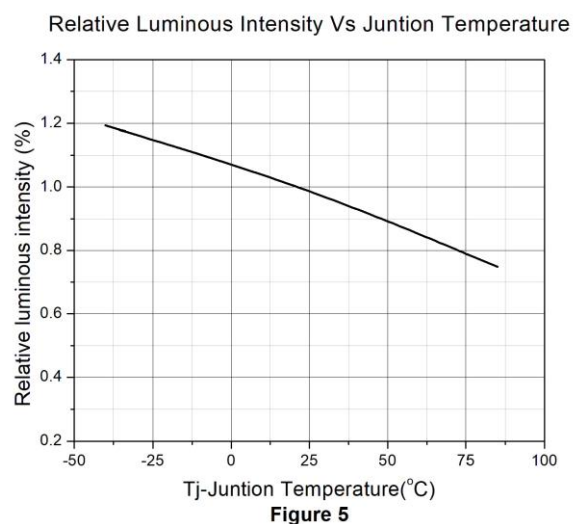
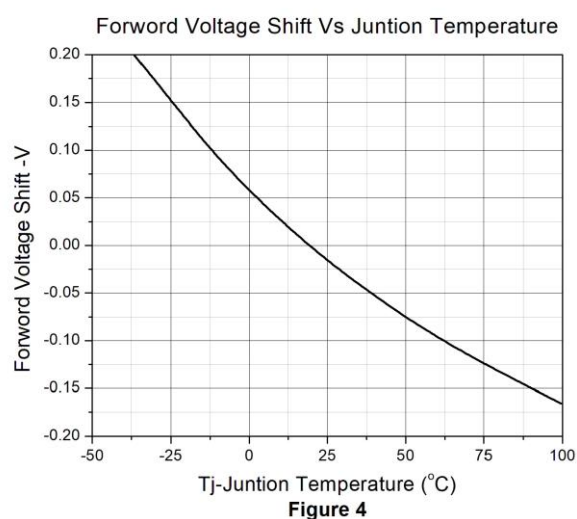
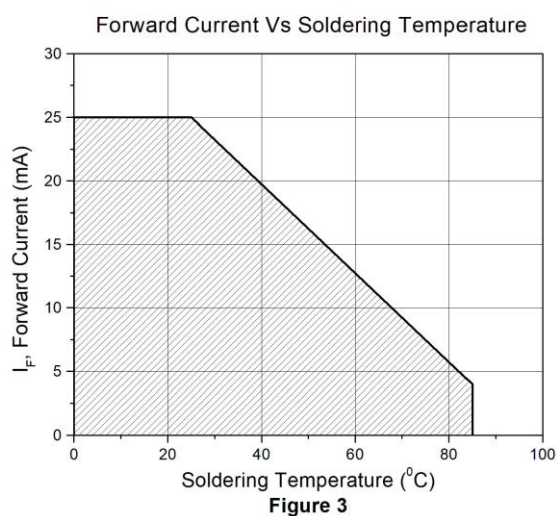
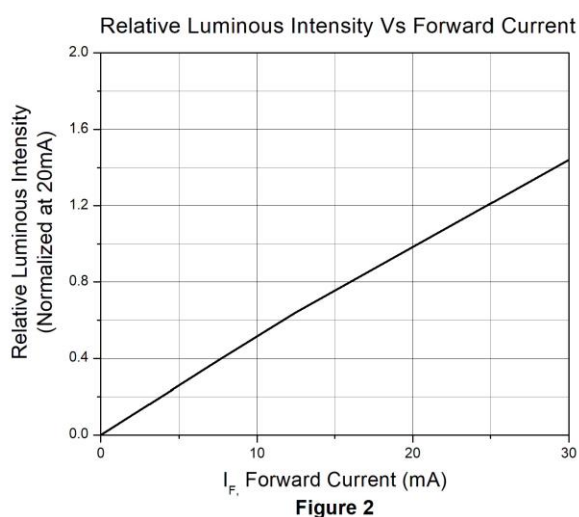
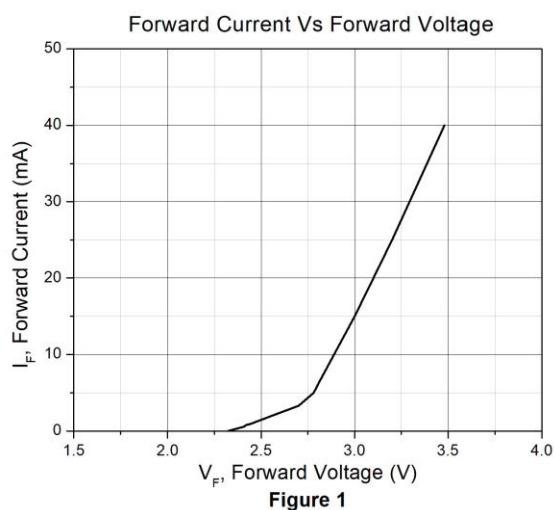




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Typical Characteristic Curves





Typical Characteristic Curves

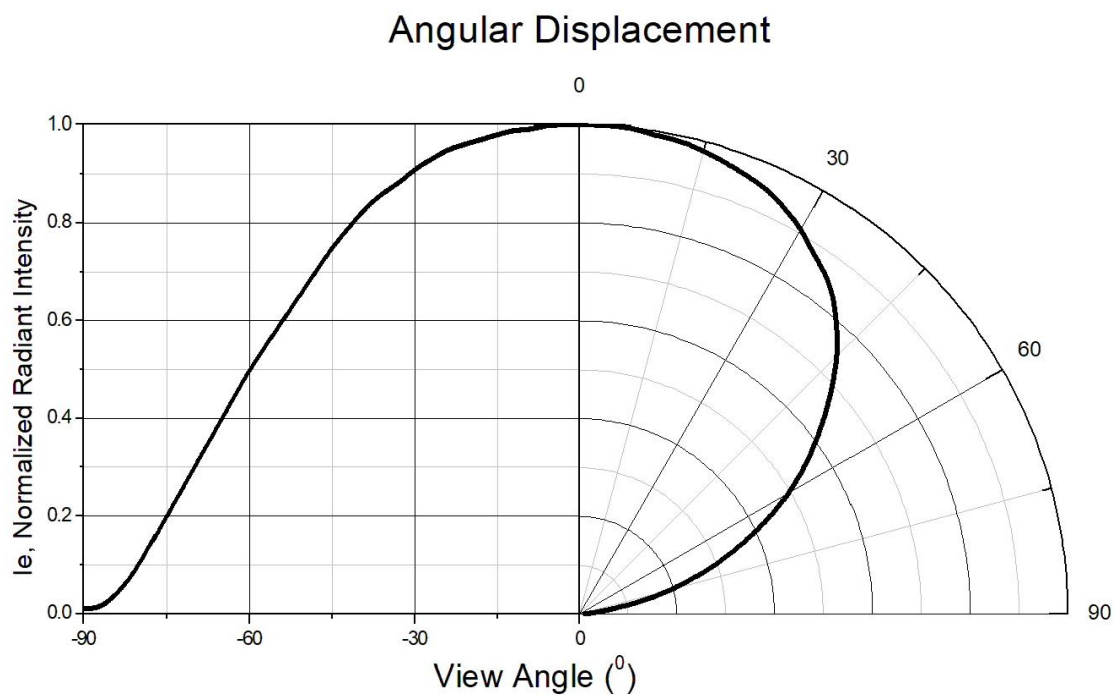


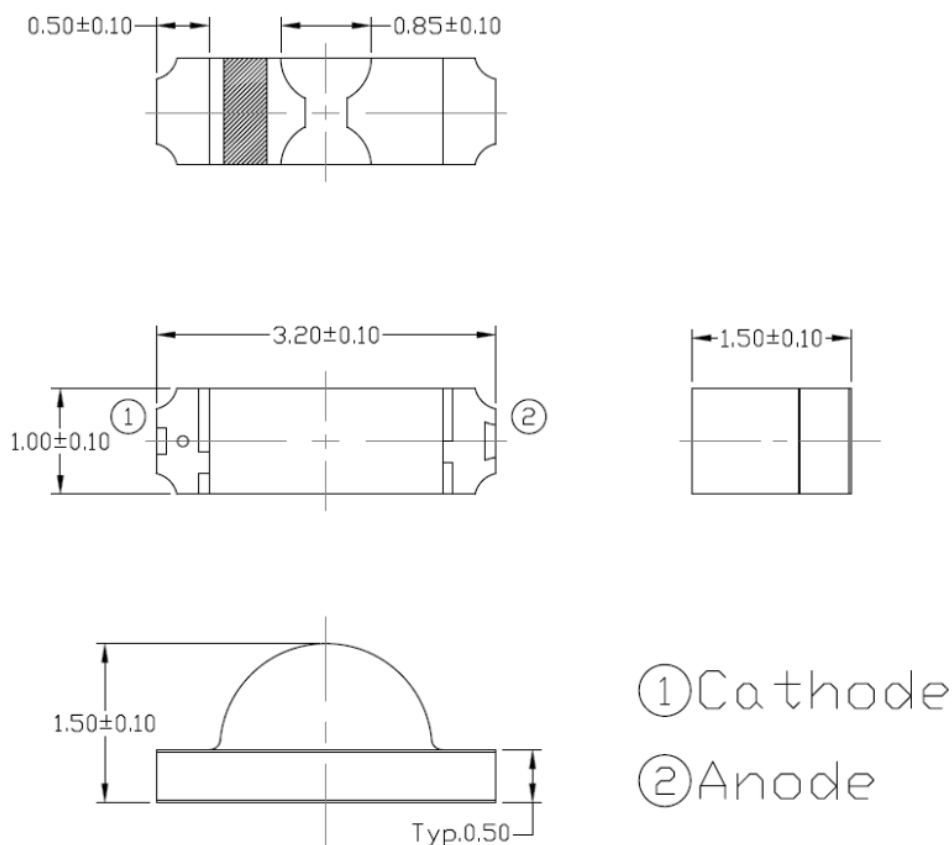
Figure 7



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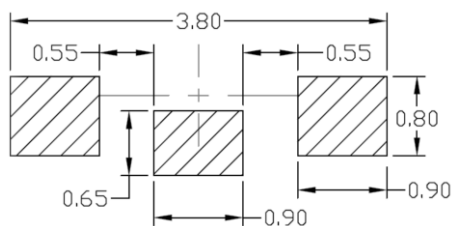
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Package Dimension *All dimensions are in mm, unless otherwise stated*



Note: Tolerance unless mentioned is ± 0.1 mm.

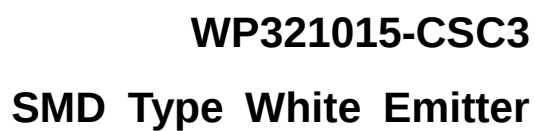
Recommended Soldering Mask *All dimensions are in mm, unless otherwise stated*



Note: Tolerance unless mentioned is ± 0.1 mm.

Ordering Information

Part Number	Description	Quantity
WP321015-CSC3	Tape & Reel	3000 pcs



Technical drawing of a circular mechanical part, showing top and side views with dimensions.

Top View (Left):

- Overall circular shape.
- Central circular feature with a cross-shaped internal structure.
- Four curved, triangular cutouts arranged symmetrically around the center.
- A rectangular label area in the upper center containing the text "Label".

Side View (Right):

- Shows the profile of the part.
- Overall height dimension: 180.
- Height of the central feature: 60.
- Width of the part: 9.
- Width of the base: 11.4.

Technical drawing of a PCB layout for a 6-pin connector. The drawing includes a top view and a side view.

Top View Dimensions:

- Overall width: 8.00
- Overall length: 12.00
- Pad diameter: $\phi 1.50$
- Pad spacing (center-to-center): 4.00
- Distance from top edge to top row of pads: 1.75
- Distance from bottom edge to bottom row of pads: 3.45
- Distance from left edge to first pad center: 4.00
- Distance between last pad center and right edge: 4.00

Side View Dimensions:

- Board thickness: 0.23
- Pad thickness: 1.20

Other Features:

- Polarity:** Indicated by a symbol on the left.
- Input Direction:** Indicated by an arrow at the top.
- Internal Features:** The pads have a central circular hole with a diameter of $\phi 1.00$.

Rev 2
Jan, 2021



Label Form Specification

CT Micro
International Corporation

MSL-X
MADE IN CHINA

CPN: XXXXXXXXXXXXXXXXX
|||||

Part no: XXXXXXXXXXXXX
|||||

Serial no: XXXXXXXX
|||||

Lot no: XXXXXXXX
|||||

Qty: XXXXXX Date Code: YWWJ
||||| |||||

IV: XX WD:XX VF:XX
||||| ||||| |||||

QR Code

Pb
RoHS

CPN : Customer Part Number

Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date

IV : Bin Code of Luminous Intensity

WD : Bin Code of Dominant Wavelength

VF : Bin Code of Forward Voltage

MADE IN CHINA: Production Place

Storage Condition

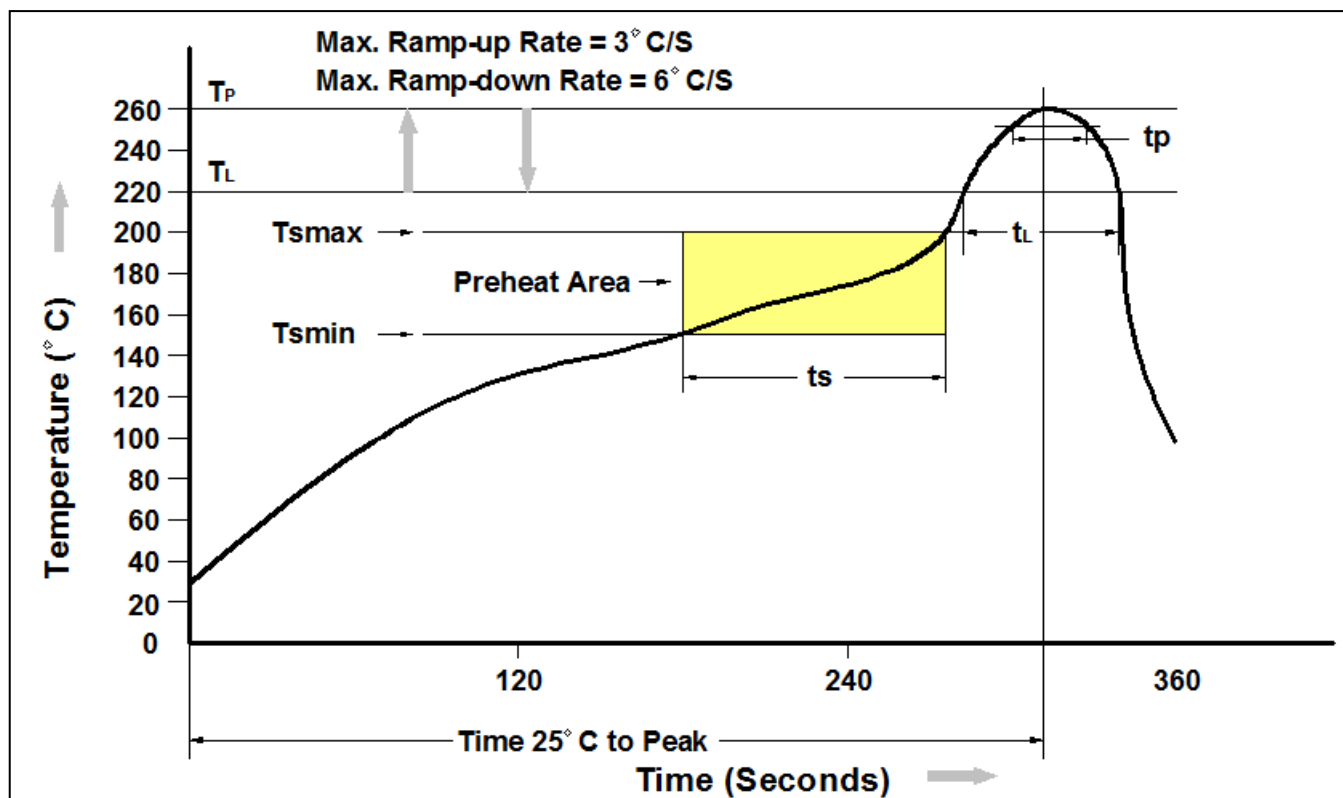
1. Do not open moisture proof bag before the products are ready to use.
2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening.
Shelf life of non-opened bag is 12 months after the bag sealing date.
3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



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Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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